

TOSHIBA Field-Effect Transistor Silicon N Channel MOS Type

## SSM3K7002AFU

High-Speed Switching Applications

Analog Switch Applications

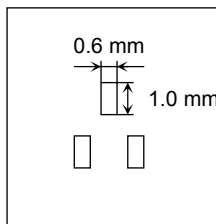
- Small package
- Low ON-resistance :  $R_{on} = 3.3 \Omega$  (max) (@ $V_{GS} = 4.5 V$ )  
 :  $R_{on} = 3.2 \Omega$  (max) (@ $V_{GS} = 5 V$ )  
 :  $R_{on} = 3.0 \Omega$  (max) (@ $V_{GS} = 10 V$ )

### Absolute Maximum Ratings (Ta = 25°C)

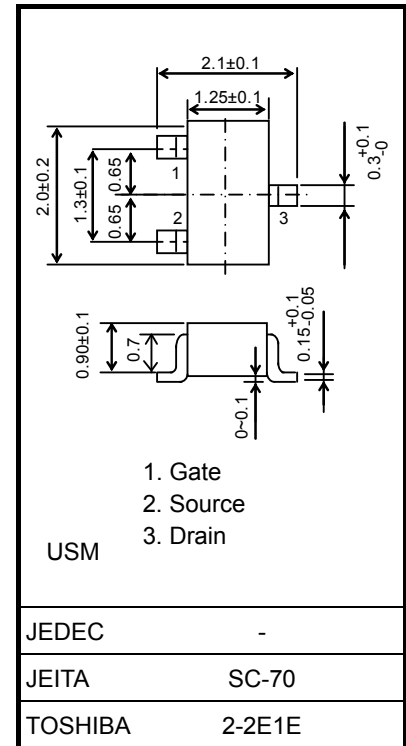
Characteristics	Symbol	Rating	Unit
Drain-source voltage	$V_{DSS}$	60	V
Gate-source voltage	$V_{GSS}$	$\pm 20$	V
Drain current	DC	$I_D$	200
	Pulse	$I_{DP}$	800
Drain power dissipation (Ta = 25°C)	$P_D$ (Note 1)	150	mW
Channel temperature	$T_{ch}$	150	°C
Storage temperature range	$T_{stg}$	-55 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.  
 Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: mounted on FR4 board  
 (25.4 mm × 25.4 mm × 1.6 t, Cu Pad: 0.6mm<sup>2</sup> × 3)



Unit: mm



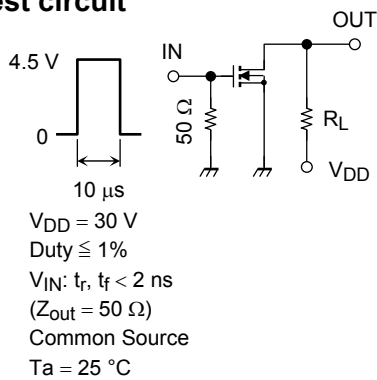
Weight: 6 mg (typ.)

### Electrical Characteristics (Ta = 25°C)

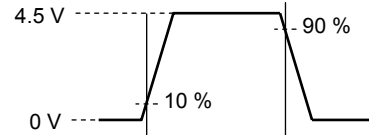
Characteristics	Symbol	Test Condition	Min	Typ	Max	Unit
Gate leakage current	$I_{GSS}$	$V_{GS} = \pm 20 V, V_{DS} = 0 V$	—	—	$\pm 0.1$	$\mu A$
Drain-source breakdown voltage	$V_{(BR)DSS}$	$I_D = 0.1 mA, V_{GS} = 0 V$	60	—	—	V
Drain cutoff current	$I_{DSS}$	$V_{DS} = 60 V, V_{GS} = 0 V$	—	—	1	$\mu A$
Gate threshold voltage	$V_{th}$	$V_{DS} = 10 V, I_D = 0.25 mA$	1.0	—	2.5	V
Forward transfer admittance	$ Y_{fs} $	$V_{DS} = 10 V, I_D = 200 mA$	205	—	—	mS
Drain-source ON-resistance	$R_{DS(ON)}$	$I_D = 500 mA, V_{GS} = 10 V$	—	1.5	3.0	$\Omega$
		$I_D = 100 mA, V_{GS} = 5 V$	—	1.7	3.2	
		$I_D = 100 mA, V_{GS} = 4.5 V$	—	1.8	3.3	
Input capacitance	$C_{iss}$	$V_{DS} = 25 V, V_{GS} = 0, f = 1 MHz$	—	16	—	pF
Reverse transfer capacitance	$C_{rss}$		—	2.3	—	
Output capacitance	$C_{oss}$		—	6.1	—	
Switching time	Turn-on delay time	$t_{d(on)}$	$V_{DD} = 30 V, I_D = 200 mA, V_{GS} = 0 \text{ to } 4.5 V$		—	ns
	Turn-off delay time	$t_{d(off)}$	—	3	10	
			—	7	20	

## Switching Time Test Circuit

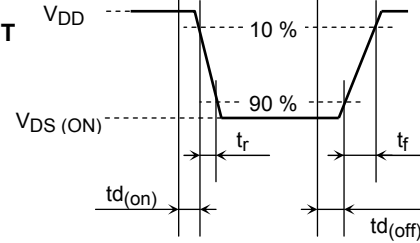
### (a) Test circuit



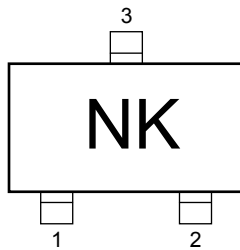
### (b) $V_{IN}$



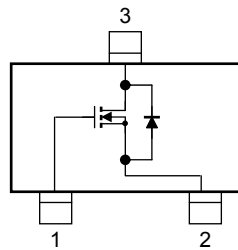
### (c) $V_{OUT}$



### Marking



### Equivalent Circuit (top view)



### Precaution

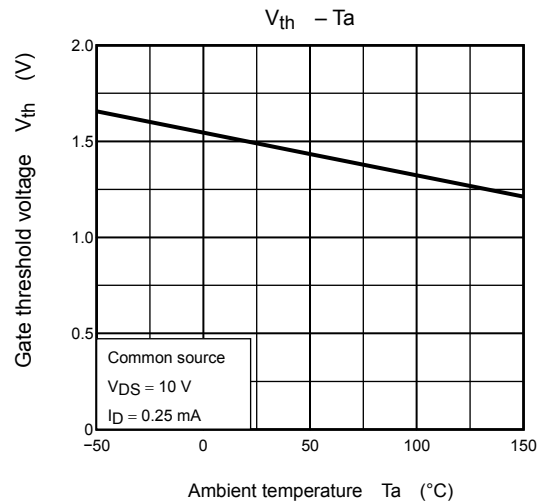
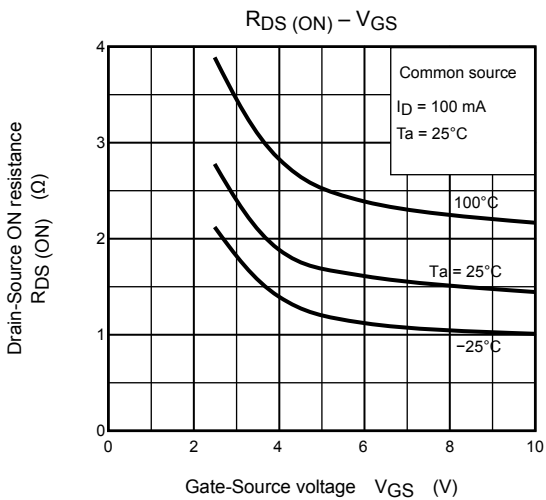
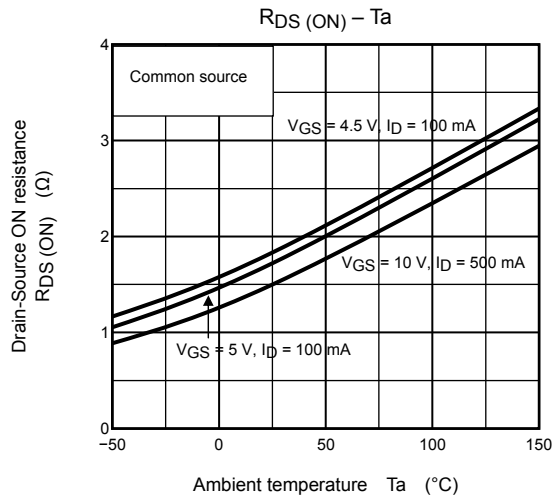
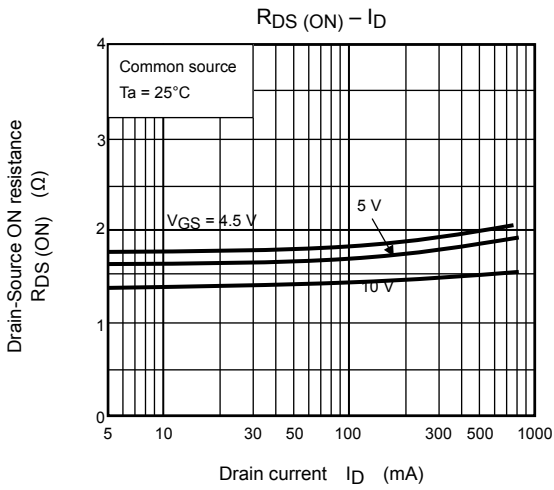
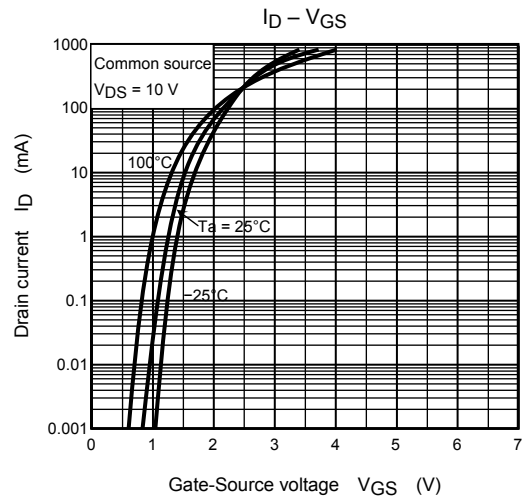
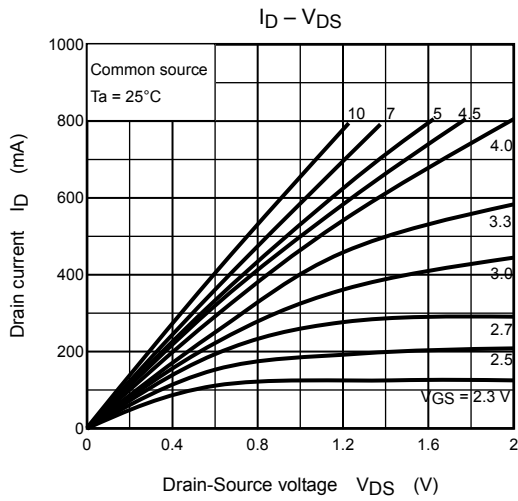
$V_{th}$  can be expressed as the voltage between gate and source when the low operating current value is  $I_D = 0.25\text{ mA}$  for this product. For normal switching operation,  $V_{GS(ON)}$  requires a higher voltage than  $V_{th}$ , and  $V_{GS(OFF)}$  requires a lower voltage than  $V_{th}$ .

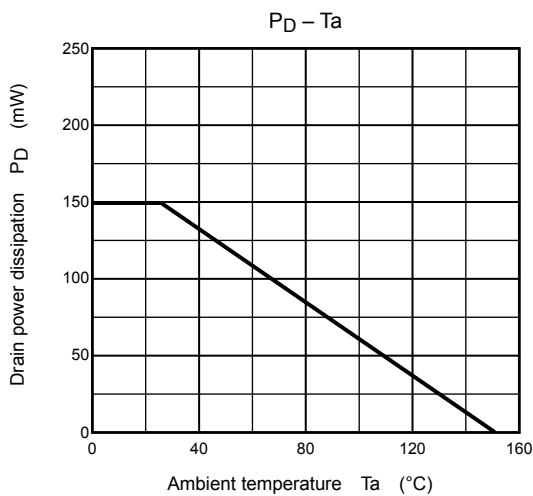
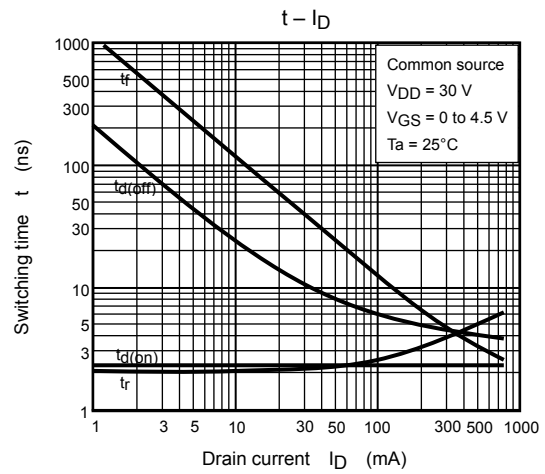
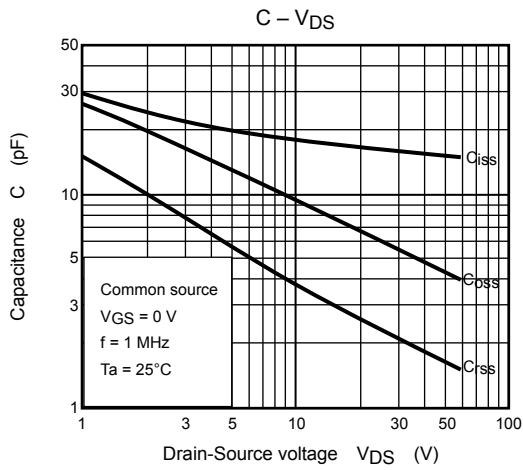
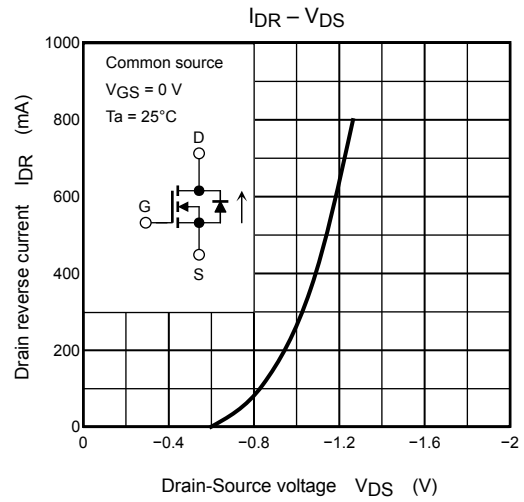
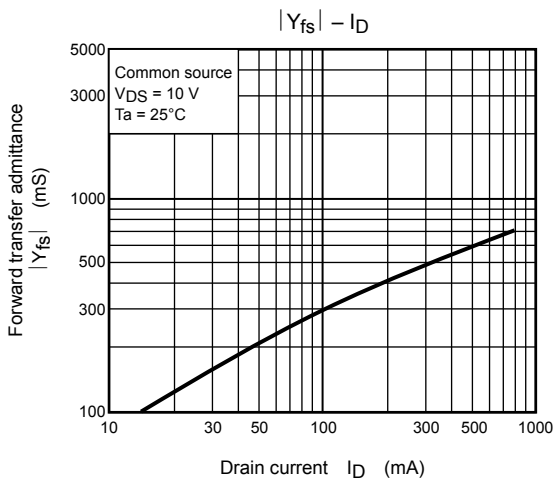
(The relationship can be established as follows:  $V_{GS(OFF)} < V_{th} < V_{GS(ON)}$ .)

Take this into consideration when using the device.

### Handling Precaution

When handling individual devices that are not yet mounted on a circuit board, make sure that the environment is protected against electrostatic discharge. Operators should wear antistatic clothing, and containers and other objects that come into direct contact with devices should be made of antistatic materials.





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